

SILICONE RESIN

SILIKOPHEN® AC 4000

Solvent-free, ambient-curing silicone resin

NEW



Heat resistant and solvent-free silicone resin

The new reactive methyl-phenyl silicone resin SILIKOPHEN® AC 4000 creates the ideal balance of heat stability and flexibility with outstanding adhesion to many substrates. The broad compatibility with other resins like SILIKOPHEN® AC 1000 or SILIKOPHEN® P80 types

enables the formulator to modify and tailor-made coating formulations to customer needs. Beside these incredible features the product outperforms in respect to storage stability at 50 °C even as a one pack formulation.

SILIKOPHEN® AC 4000 – At a Glance

Ready for the Future

- Ambient-curing
- High solid, > 99 % active matter
- Non isocyanate curing systems

Performance

- Excellent corrosion protection
- Excellent heat stability and flexibility
- Fast curing with different catalysts and hardeners

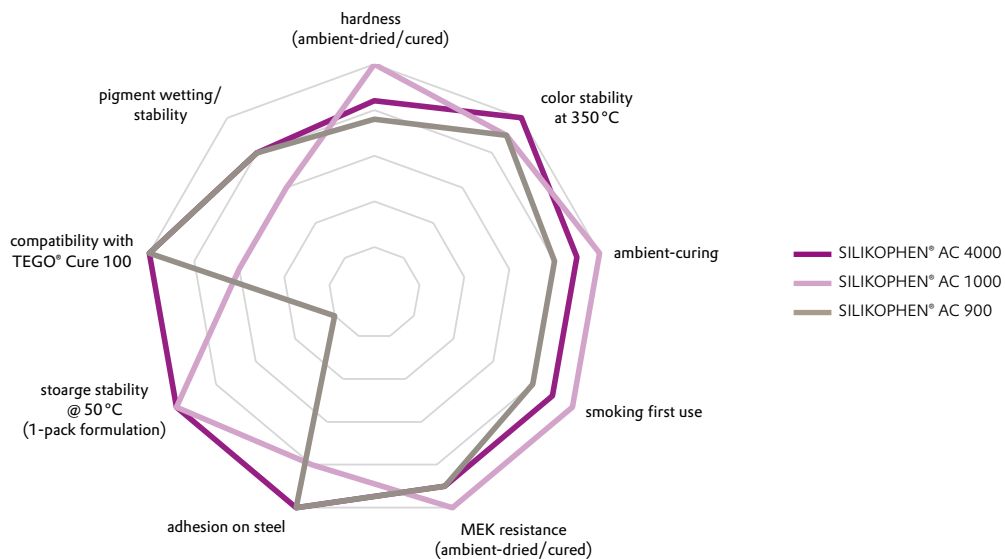
Easy to use

- Highly compatible silicone binder for several heat stable applications
- Easy and robust handling
- Excellent storage stability



Click or scan the QR-code
for more information!

Performance profile of SILIKOPHEN® AC 4000



SILIKOPHEN® P80/X



[click here](#)

SILIKOPHEN® P80/MPA



[click here](#)

SILIKOPHEN® AC 1000



[click here](#)

TEGO® Cure 100



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TECHNICAL DOCUMENT FINDER SILIKOPHEN® for Heat Resistant Applications



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